TOSHIBA

TOSHIBA ALLOY-FREE THYRISTOR

S F 8 0 0 U 2 9

HIGH POWER CONTROL APPLICATIONS

Repetitive Peak Off-State Voltage : V_{DRM} = 1600V

Repetitive Peak Reverse Voltage: VRRM

Average On-State Current $: I_{T(AV)} = 800A$

Critical Rate of Rise of On-State Current

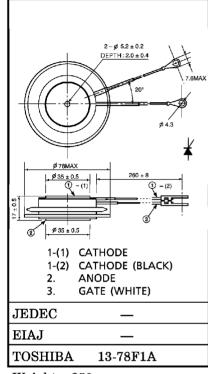
: $di/dt = 200A/\mu s$

Critical Rate of Rise of Off-State Voltage

: $dv/dt = 500V/\mu s$

Flat Package

Unit in mm



Weight: 250g

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MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	$v_{ m DRM} \ v_{ m RRM}$	1600	V
Non-Repetitive Peak Reverse Voltage (Non-Repetitive $< 5 \text{ms}, T_j = 0 \sim 125 ^{\circ}\text{C}$)	$v_{ m RSM}$	1700	V
R.M.S On-State Current	IT (RMS)	1260	Α
Average On-State Current	I _{T (AV)}	800	Α
Peak One Cycle Surge On-State Current (Non-Repetitive)	I _{TSM}	12000 (50Hz) 13200 (60Hz)	A
I ² t Limit Value	${f I^2 t}$	720×10^{3}	A^2s
Critical Rate of Rise of On-State Current (Note)	di / dt	200	A/μs
Peak Gate Power Dissipation	PGM	20	W
Average Gate Power Dissipation	PG (AV)	4	W
Peak Forward Gate Current	I _{GM}	4	A
Peak Forward Gate Voltage	v_{FGM}	20	V
Peak Reverse Gate Voltage	v_{RGM}	5	V
Junction Temperature	T_{j}	-40~125	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~125	°C
Mounting Force	_	14.7 ± 1.5	kN

Note : V_D=1/2 Rated, T_j=120°C, Gate Supply (V_G=15V, R_G=8 Ω , t_r \leq 1 μ s)

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	IDRM IRRM	$V_{DRM} = V_{RRM} = 1600V$ $T_{j} = 125^{\circ}C$		_	35	mA
Peak On-State Voltage	$V_{ ext{TM}}$	$I_{TM} = 2500A, T_j = 25^{\circ}C$		_	2.15	V
Gate Trigger Voltage	v_{GT}		$T_j = -40$ °C		5.0	V
		$V_D = 6V, R_L = 6\Omega$	$T_j = 25$ °C		4.0	
Gate Trigger Current	I_{GT}		$T_j = -40$ °C	_	460	mA
			$T_j = 25$ °C	_	320	
Gate Non-Trigger Voltage	v_{GD}	$V_D = 1/2$ Rated, $T_j = 125$ °C		0.2	_	V
Gate Non-Trigger Current	$_{ m IGD}$			5		mA
Delay Time	$^{ m t_d}$	V _D =1/2 Rated, T _j =25°C		_	4	μ s
Gate Turn-On Time	t _{gt}	Gate Supply $(V_G=15V, R_G=8\Omega, t_r\leq 1\mu s)$		_	6	μs
Holding Current	I_{H}	$T_j=25$ °C, $R_L=6\Omega$			300	mA
Critical Rate of Rise of Off-State Voltage	dv/dt	V _{DRM} =2/3 Rated, T _j =125°C Gate Open, Exponential Rise		500	_	V/μs
Thermal Resistance (Junction to Case)	R _{th (j-f)}	DC		_	0.04	°C/W